# **CERAMIC SMD CRYSTAL**

ABM3C

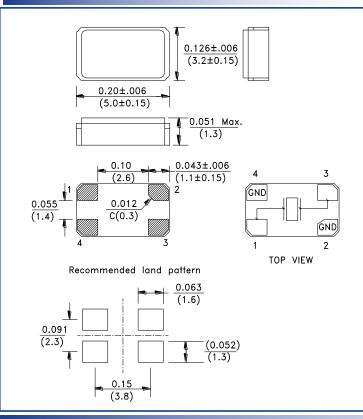
**RoHS/RoHS II Compliant** 





5.0 x 3.2 x 1.3mm

### **OUTLINE DRAWING:**



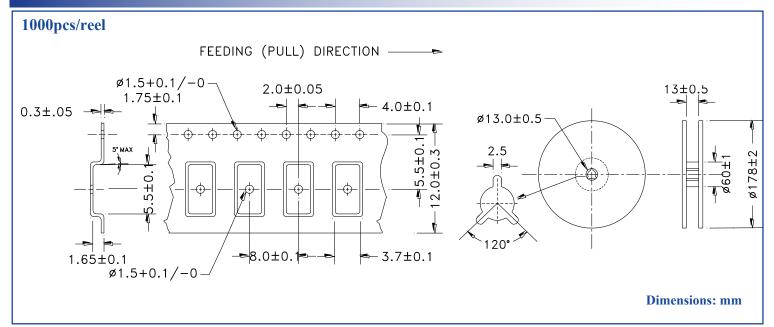
#### **Sealing Method:**

Glass Sealing for parts with Traceability Code ending in "X" Seam Sealing for parts with Traceability Code ending in "C" and "F"

Note: Due to material availability, the chamfer could be located on pin #1 or #2. Be advised that the chamfer location has no impact on the electrical performance of the device.

**Dimensions: inches (mm)** 

### **TAPE & REEL:**



**REVISED: 09-07-21** 

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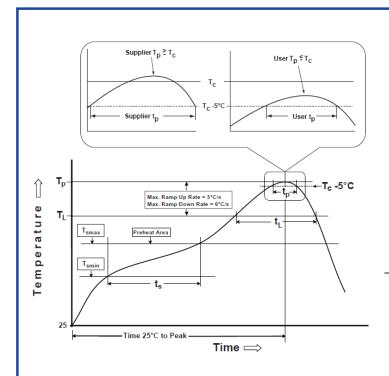
**RoHS/RoHS II Compliant** 





5.0 x 3.2 x 1.3mm

### **REFLOW PROFILE:**



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Table 2

**Pb-Free Process** Classification Temperatures (Tc) Volume mm<sup>3</sup> Package Volume mm<sup>3</sup> Volume mm<sup>3</sup> Thickness <350 350-2000 >2000 260 °C 260 °C 260 °C <1.6 mm 245 °C 1.6 mm - 2.5 mm 260°C 250 °C 250 °C 245 °C 245 °C >2.5 mm

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat / soak		
Temperature minimum (T <sub>smin</sub> )	100°C	150°C
Temperature maximum (T <sub>smax</sub> )	150°C	200°C
Time $(T_{smin} \text{ to } T_{smax})$ $(t_s)$	60 - 120 sec.	60 - 120 sec.
Average ramp-up rate (T <sub>smax</sub> to T <sub>P</sub> )	3°C/sec. max	3°C/sec. max
Liquidous temperature (T <sub>L</sub> )	183°C	217°C
Time at liquidous (t <sub>L</sub> )	60 - 150 sec.	60 - 150 sec.
Peak package body temperature (T <sub>P</sub> )*	see Table 1	see Table 2
Time (t <sub>p</sub> )** within 5°C of the specified classification temperature (T <sub>C</sub> )	20 sec.	30 sec.
Ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/sec. max	6°C/sec. max
Time 25°C to peak temperature	6 min. max	8 min. max
Reflow cycles	2 max	2 max

<sup>\*</sup>Tolerance for peak profile temperature (T<sub>P</sub>) is defined as a supplier minimum and a user maximum.

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<sup>\*\*</sup>Tolerance for time at peak profile temperature  $(t_p)$  is defined as supplier minimum and a user maximum.